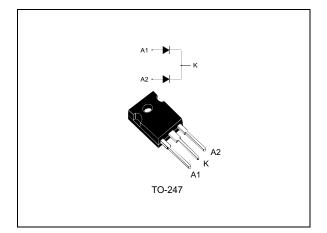


STPS6045C

Power Schottky Rectifier

Datasheet - production data



Features

- Very small conduction losses
- Negligible switching losses
- Extreme fast switching
- Low thermal resistance
- Avalanche capability specified

Description

Dual center tap Schottky rectifier suited for switch mode power supply and high frequency DC to DC converters. Packaged in TO-247, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.

Table 1. D	evice	summary
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Symbol	Value
I _F (AV)	2 x 30 A
V _{RRM}	45 V
T _j (max.)	175 °C
V _F (max.)	0.63 V

Characteristics

Symbol	Para	Value	Unit		
V _{RRM}	Repetitive peak reverse volt	age	45	V	
I _{F(RMS)}	RMS forward current		60	А	
I _{F(AV)}	Average forward current $\delta = 0.5$	1 C = 150 °C per diode		А	
I _{FSM}	Surge non repetitive forward current			А	
I _{RRM}	Repetive peak reverse current	tp = 2 μs square F = 1 kHz	1	А	
I _{RSM}	Non repetitive peak reverse current tp = 100 µs square		3	А	
P _{ARM}	Repetitive peak avalanche power	tp = 1 μs T _j = 25 °C	10600	W	
T _{stg}	Storage temperature range	Storage temperature range			
Тj	Maximum operating junction	175	°C		
dV/dt	Critical rate of rise or reverse	10000	V/µs		

Table 2. Absolute	ratings	(limitina	values.	per diode))
					,

1. $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. thermal resistances

Symbol	Parameter		Value	Unit
R _{th(j-c)}	Junction to case	Per diode Total	0.95 0.55	°C/W
R _{th(c)}		Coupling	0.15	

When the diodes 1 and 2 are simultaneously:

 ΔT_j (diode 1) = P(diode1) x R_{th(j-c)} (Per diode) + P(diode 2) x R_{th(c)}



Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V_ - V	-		500	μA
		T _j = 125 °C	V _R = V _{RRM}	-	20	80	mA
VF ⁽¹⁾	Forward voltage drop	T _j = 125 °C	IF = 30 A	-	0.53	0.63	
		T _j = 25 °C	IF = 60 A	-		0.84	V
		T _j = 125 °C	IF = 60 A	-	0.68	0.78	

1. Pulse test: tp = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation:

 $P + 0.48 \times I_{F(AV)} + 0.005 I_{F(RMS)}^{2}$

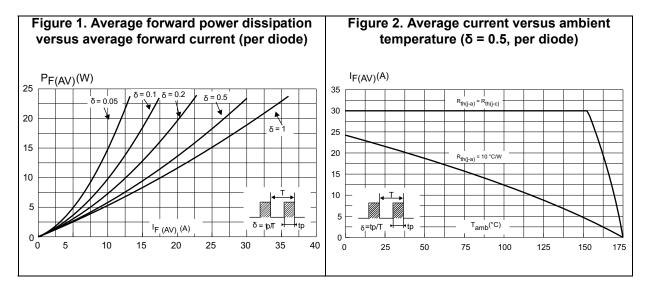
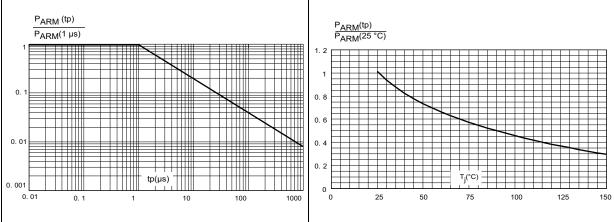
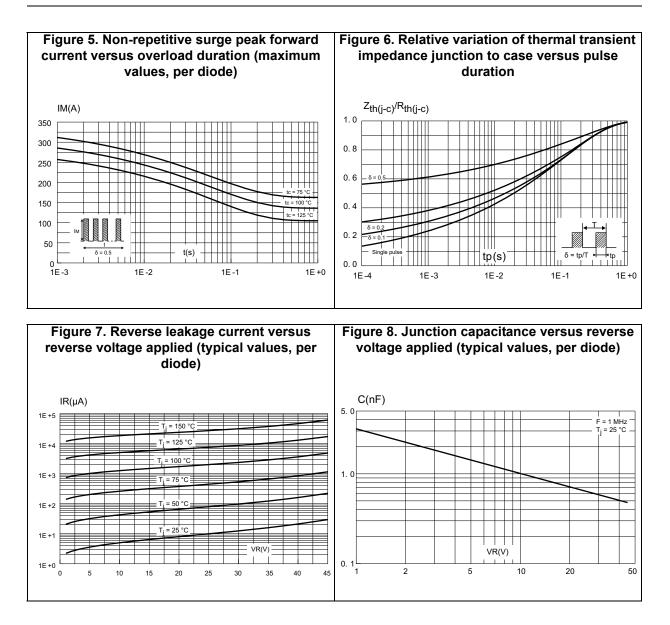


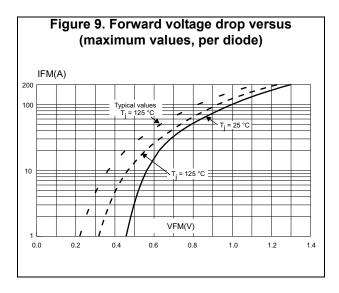
Figure 3. Normalized avalanche power derating
versus pulse durationFigure 4. Normalized avalanche power derating
versus junction temperature



57







1 Package information

- Cooling method: by conduction (C)
- Recommended torque value: 0.8 N.m.
- Maximum torque value: 1.0 N.m.
- Epoxy meets UL94, V0

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

1.1 TO-247 package information

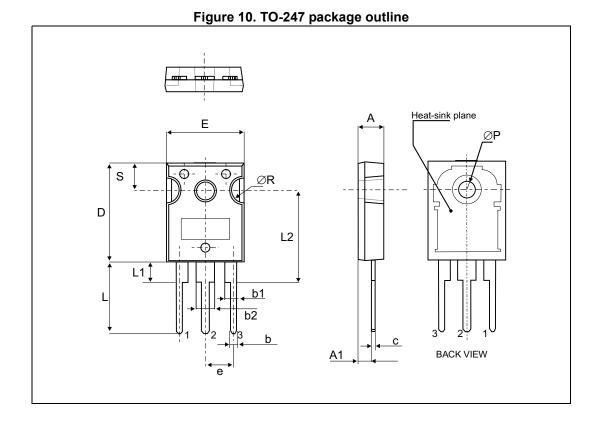




	Table 5. TO-247 package mechanical data						
			Dime	nsions			
Ref.		Millimeters			Inches ⁽¹⁾		
	Тур.	Min.	Max.	Тур.	Min.	Max.	
А		4.85	5.15		0.191	0.203	
A1		2.20	2.60		0.086	0.102	
b		1.0	1.40		0.039	0.055	
b1		2.0	2.40		0.078	0.094	
b2		3.0	3.40		0.118	0.133	
С		0.40	0.80		0.015	0.031	
D		19.85	20.15		0.781	0.793	
Е		15.45	15.75		0.608	0.620	
е	5.50	5.30	5.60		0.209	0.220	
L		14.20	14.80		0.559	0.582	
L1		3.70	4.30		0.145	0.169	
L2	18.50			0.728			
ØP		3.55	3.65		0.139	0.143	
ØR		4.50	5.50		0.177	0.217	
S	5.50	5.30	5.70		0.209	0.224	

1. Values in inches are converted from mm and rounded to 4 decimal digits.



2 Ordering information

Table 6. Ordering information

Туре	Marking	Package	Weight	Base qty.	Delivery mode
STPS6045CW	STPS6045CW	TO-247	4.36 g.	30	Tube

3 Revision history

Table 7. Document revision history

Date	Revision	Changes
24-Jul-2012	7	
11-Dec-2015	8	Format updated to current standard. Update of <i>Table 2</i> and <i>Table 3</i> and <i>Table 5</i> . Update of <i>Figure 2</i> . Remove of figure 5.2.



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